# Vishay Siliconix

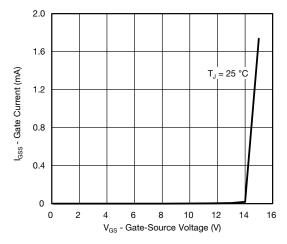
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$		-	-13	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = -250 \mu A$	-	2.6	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.5	-	-1.2	V
0.1		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	-	-	± 60	μΑ
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$	-	-	± 1	
		V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V	-	-	-1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-20	-	-	Α
	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -7 \text{ A}$	-	0.0135	0.0165	Ω
Drain-source on-state resistance a		$V_{GS} = -3.7 \text{ V}, I_D = -5 \text{ A}$	-	0.0150	0.0185	
		$V_{GS} = -2.5 \text{ V}, I_D = -5 \text{ A}$	-	0.0210	0.0300	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_D = -7 \text{ A}$	-	29	-	S
Dynamic <sup>b</sup>		-	L		L	
Input capacitance	C <sub>iss</sub>		-	2130	-	pF
Output capacitance	C <sub>oss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	290	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	280	-	
		$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -12 \text{ A}$	-	48	72	nC
Total gate charge	Q <sub>g</sub>		-	23	35	
Gate-source charge		$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -12 \text{ A}$	_	3.1	-	
Gate-drain charge	Q <sub>qd</sub>		_	6.7	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz	1.2	6	12	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	25	50	
Rise time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_1 = 1 \Omega$	-	25	50	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -9.5 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	55	110	
Fall time	t <sub>f</sub>		-	20	40	
Turn-on delay time	t <sub>d(on)</sub>		-	7	15	ns
Rise time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_1 = 1 \Omega$	_	10	20	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -9.5 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	60	120	
Fall time	t <sub>f</sub>		-	17	35	
Drain-Source Body Diode Characterist			L	ı		
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	-12	А
Pulse diode forward current	I <sub>SM</sub>	-	-	-	-50	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -9.5 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	15	30	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -9.5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	5	10	nC
Reverse recovery fall time	t <sub>a</sub>	$T_{\rm J} = 25  ^{\circ}{\rm C}$	-	7	-	ns
					1	

#### Notes

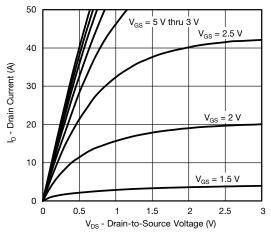
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

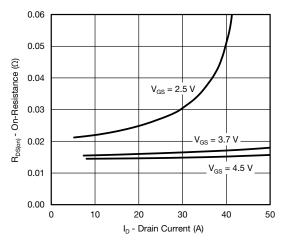




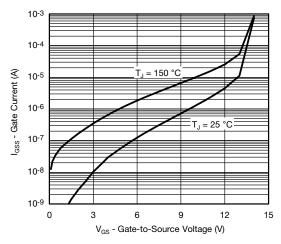
#### Gate Current vs. Gate-Source Voltage



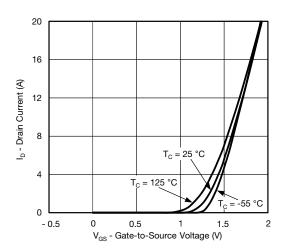
**Output Characteristics** 



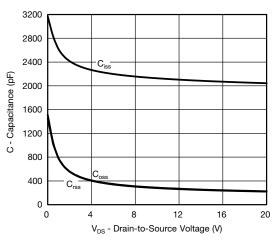
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage

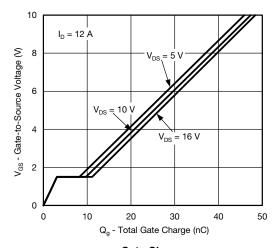


**Transfer Characteristics** 

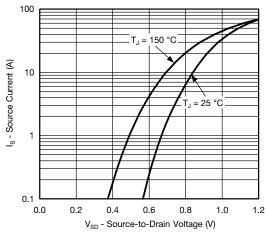


Capacitance

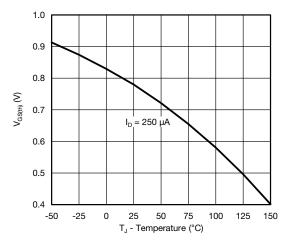




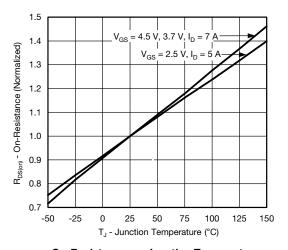
### **Gate Charge**



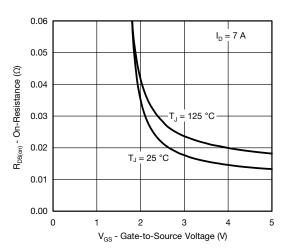
Source-Drain Diode Forward Voltage



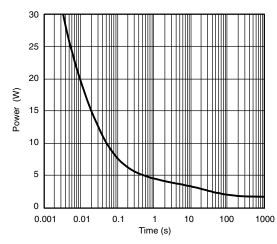
**Threshold Voltage** 



On-Resistance vs. Junction Temperature

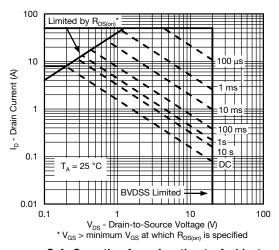


On-Resistance vs. Gate-to-Source Voltage

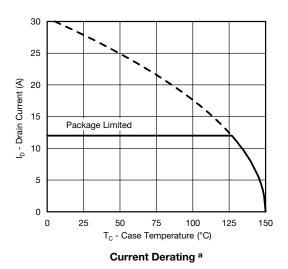


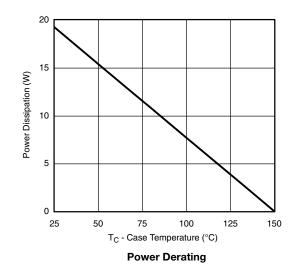
Single Pulse Power, Junction-to-Ambient





Safe Operating Area, Junction-to-Ambient

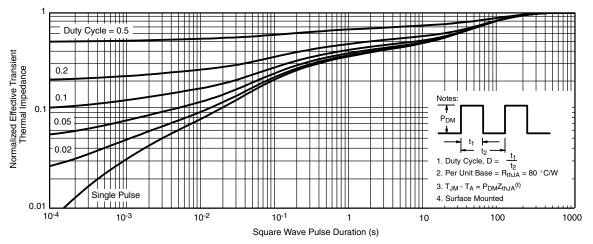




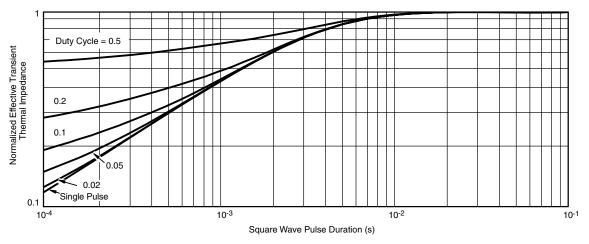
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



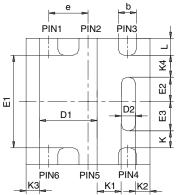
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?63619">www.vishay.com/ppg?63619</a>.



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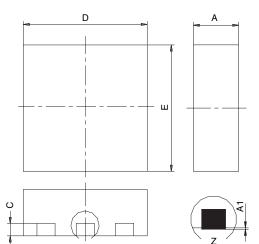
## PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
  Package outline exclusive of mold flash and metal burr
  Package outline inclusive of plating

DIM	SINGLE PAD						DUAL PAD					
	MILLIMETERS			INCHES		MILLIMETERS			INCHES			
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
<b>A</b> 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е	0.65 BSC		0.026 BSC		0.65 BSC		0.026 BSC					
K	0.275 TYP		0.011 TYP		0.275 TYP		0.011 TYP					
K1	0.400 TYP 0.016 TYP			ı	0.320 TYP			0.013 TYP				
K2	0.240 TYP 0.009 TYP			ı	0.252 TYP			0.010 TYP				
К3		0.225 TYP	1	0.009 TYP								
K4	0.355 TYP 0.014 TYP											
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
Т							0.05	0.10	0.15	0.002	0.004	0.006

DETAIL Z

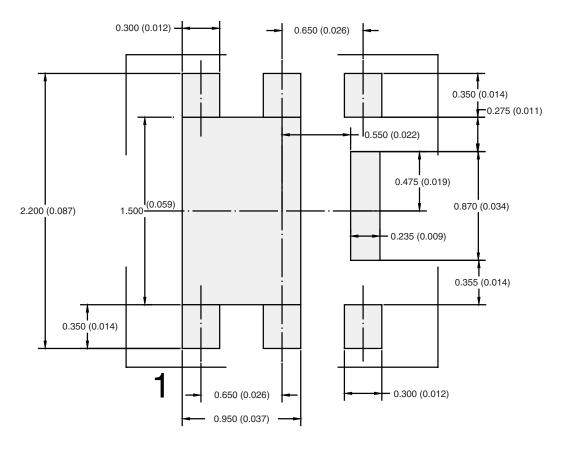
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Document Number: 73001

06-Aug-07



## RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

Return to Index

ATTLICATION NOTE

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Vishay

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